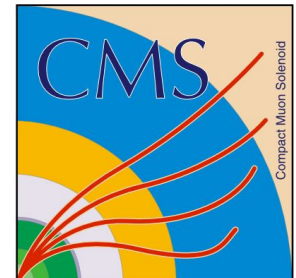
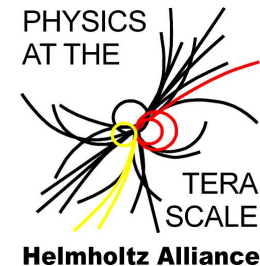


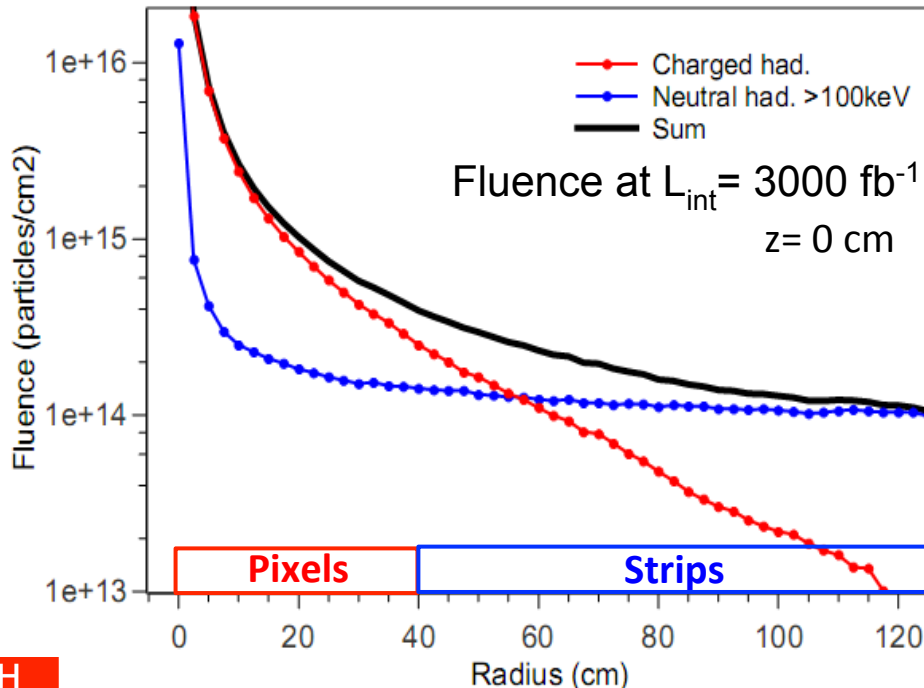
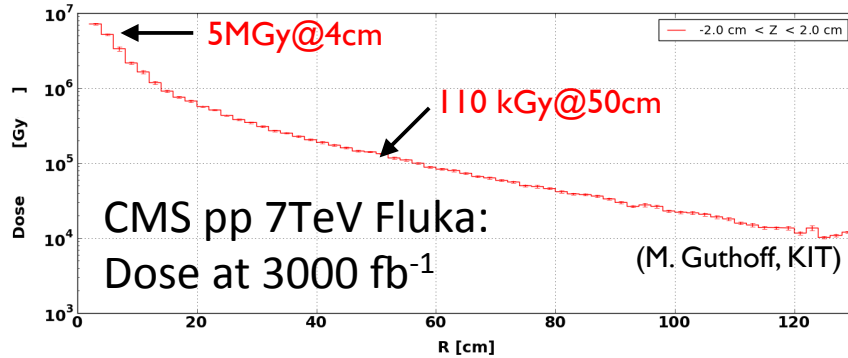
Radiation Damage in Silicon: Investigation and Simulation

A. Junkes for the PETTL Group

December 2nd 2014, DESY
8th Annual Meeting of the Helmholtz Alliance
“Physics at the Terascale”



Radiation Damage in Pixel Sensors



Radiation hardness to $\Phi \approx 2E16$ cm⁻² for innermost pixel layer

- Phase 2 will yield 3,000 fb⁻¹ and about 300 fb⁻¹/year.
- Radiation damage of the previous 10 years in only one year!

Surface damage not negligible for pixel region:

- Dose at 4 cm: 5 MGy
 - Dose at 50 cm: 110 kGy
- Understand impact

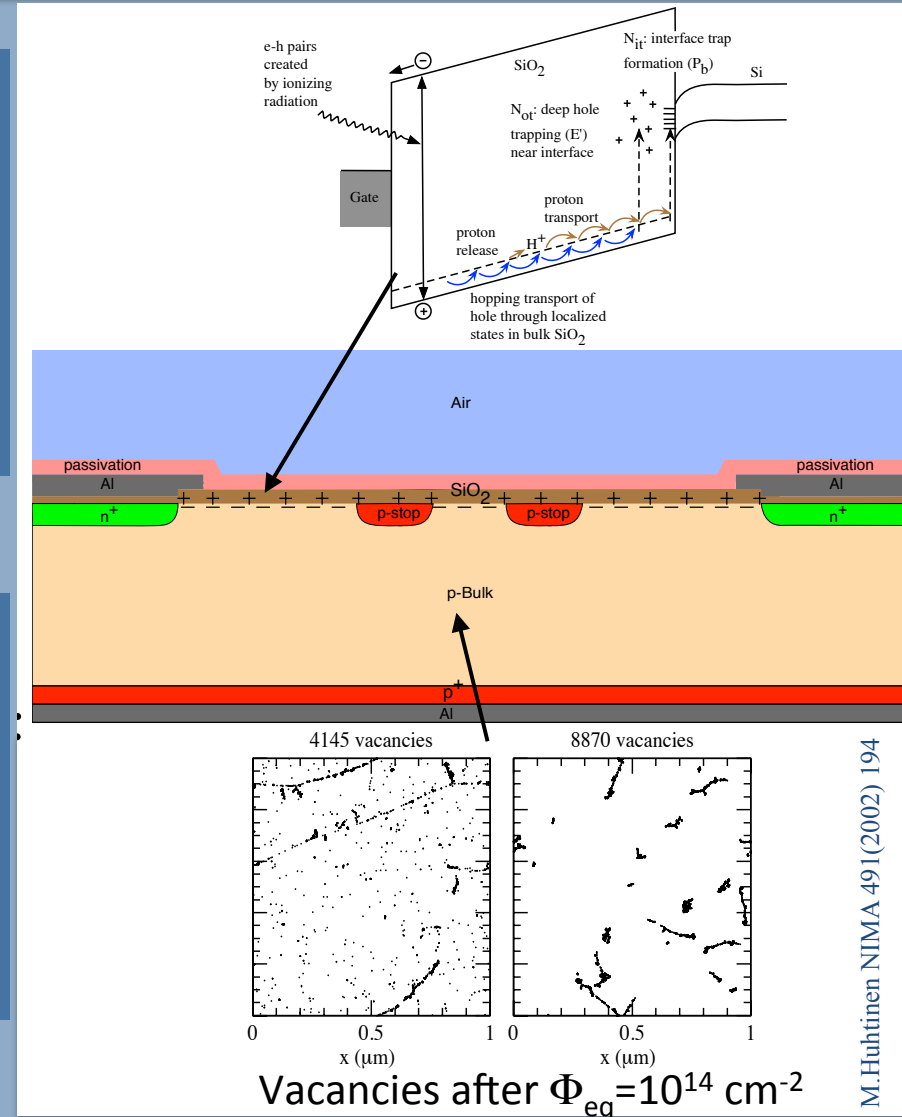
Impact of Radiation damage

Surface damage (Ionising Energy Loss):

- Increase of oxide charge
- Increase of interface traps
- ➔ Increase of leakage current
- ➔ Change of break-down voltage
- ➔ Change of charge collection

Bulk damage (Non-Ionising Energy Loss):

- Cluster and point defects
- ➔ Change of the space charge
- ➔ Change of depletion voltage
- ➔ Change of leakage current
- ➔ Change of trapping



Surface and Bulk damage

Today's knowledge:

Surface defects in p-on-n sensors:

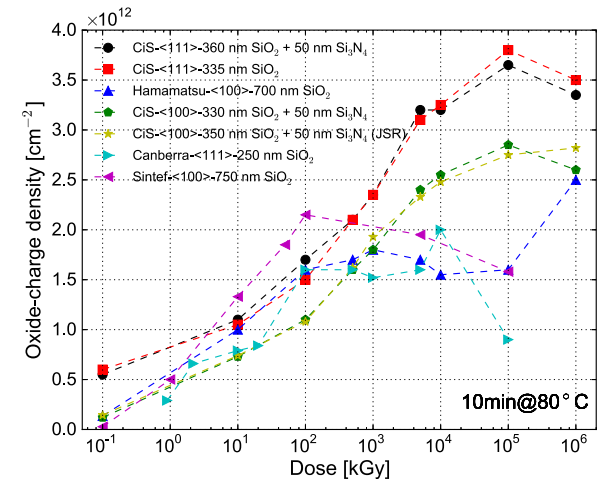
- Oxide-charges build-up from photons
- Some understanding of the generation of interface-states

→ Effective model for simulations

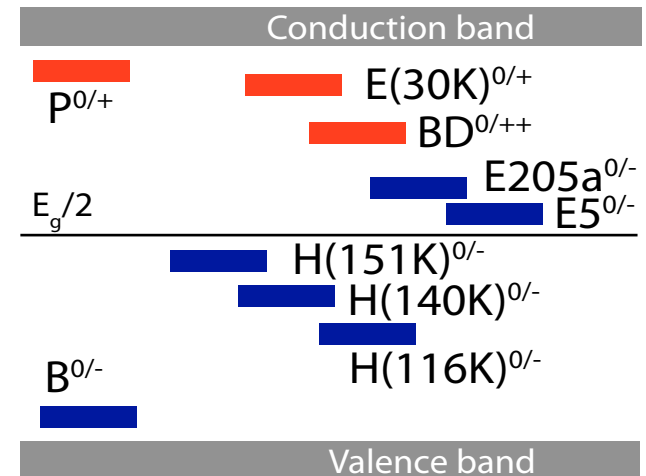
Bulk defects meanwhile also in n-on-p sensors:

- Leakage current scales with fluence, originates from cluster defects, mechanism not fully understood
 - Several bulk defects with impact on depletion voltage found, impact on space charge not fully understood
 - Some defects suspected to do trapping
- Several models with 2-, 3-, 5- levels ("free parameters") available for up to $\Phi=10^{15} \text{ cm}^{-2}$

Dose dependence of oxide-charge density

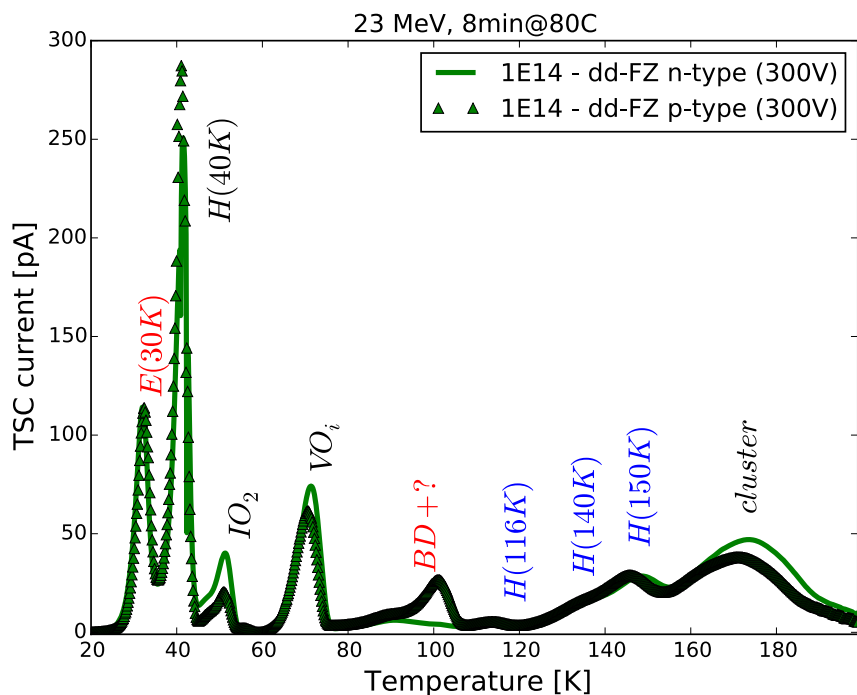


PhD thesis J. Zhang Uni Hamburg 2013



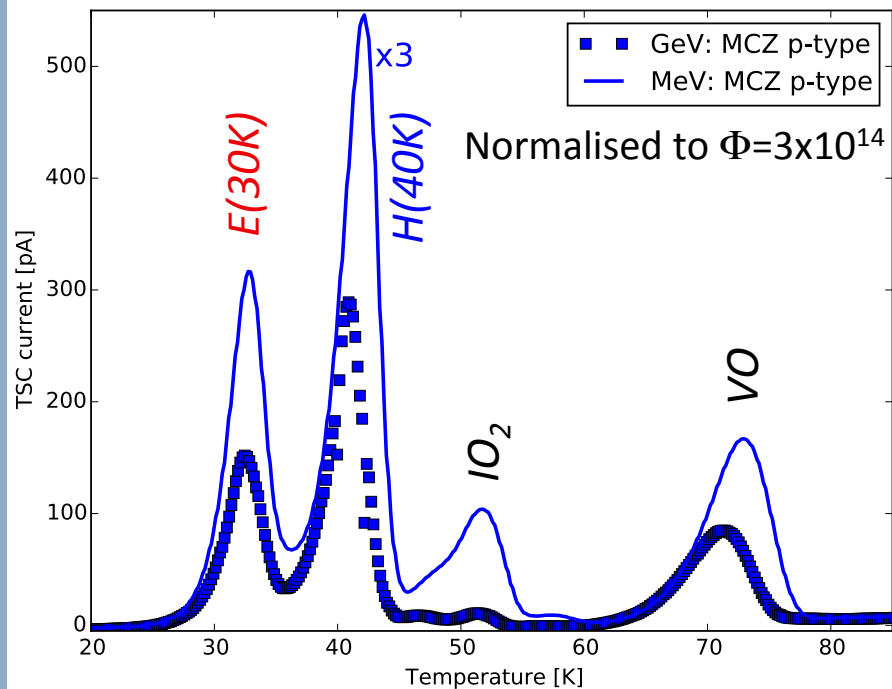
Defect Studies with TSC

Comparison n- vs. p-bulk



- No big differences between n- & p-bulk sensors
- N-type models valid also for p-type

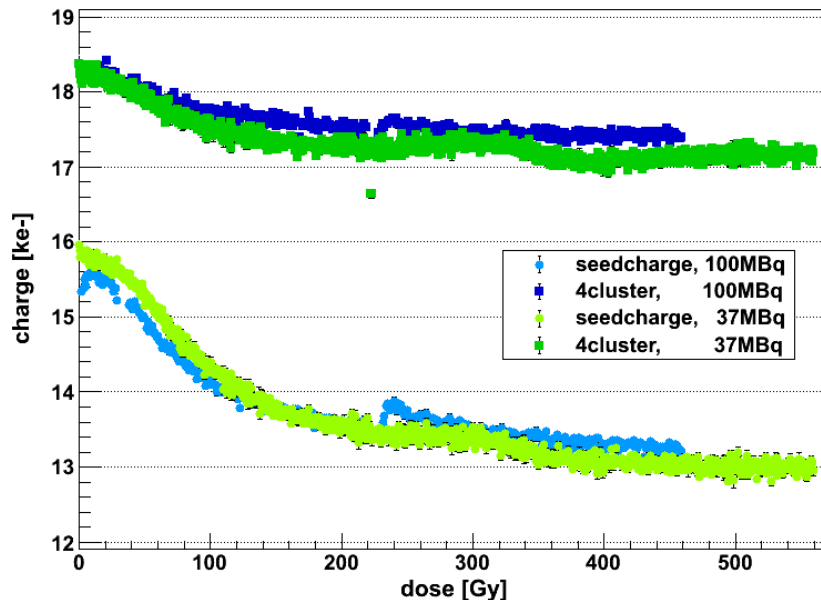
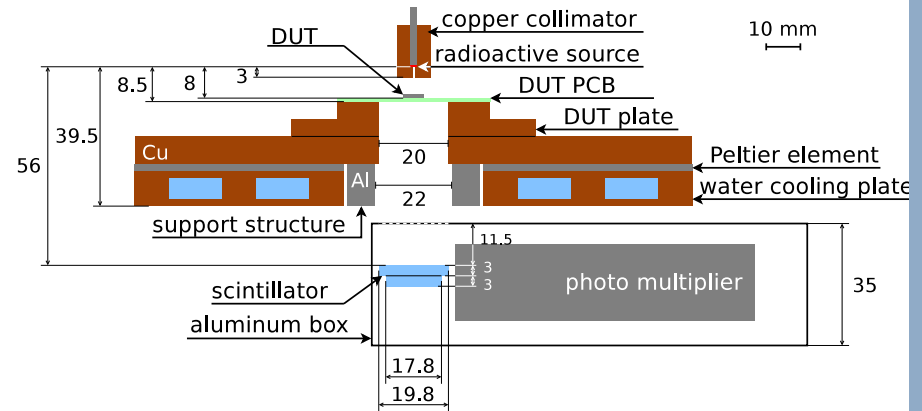
GeV proton vs. MeV proton irradiation



- Big difference seen in low-Temperature region
- Point-like defect (donor-like defects) suppressed

Relevance of Surface Damage

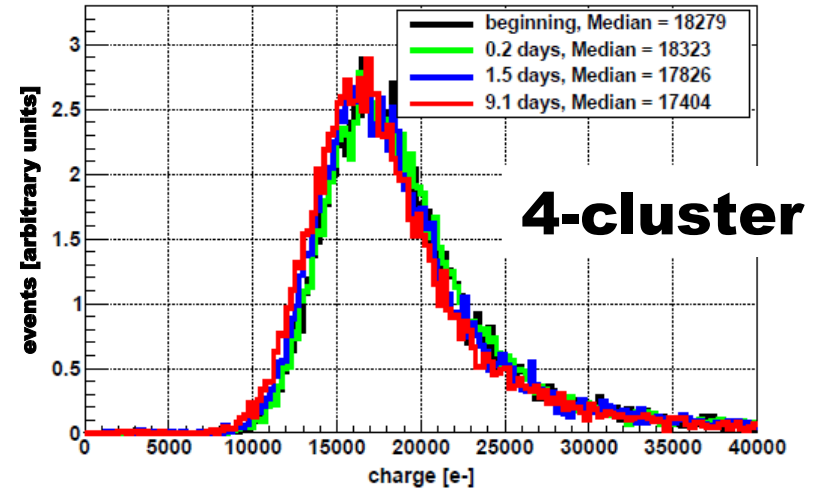
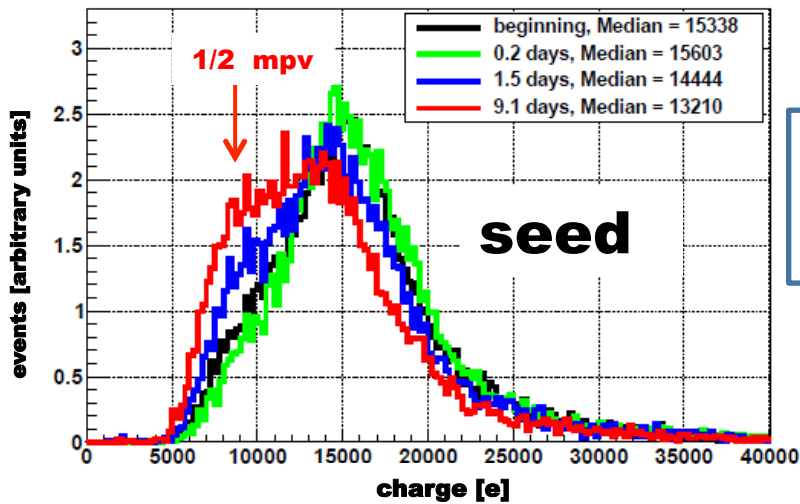
- β -Setup + ALiBaVa for readout
- ^{90}Sr source with 37 and 100 MBq
- Dose rate ≈ 2.1 Gy/h for 100 MBq source
- AC-coupled $n^+ - p$ sensor (MCZ200P):
 - p-stop isolation
 - pitch $80 \mu\text{m}$, implant width $19 \mu\text{m}$, metal width $31 \mu\text{m}$, thickness $200 \mu\text{m}$
- **Non-irradiated** sensor at 600V



- Already at ~ 200 Gy signal loss in **seed strip** $\approx 20\%$
- Loss similar to bulk damage after $1.5 \cdot 10^{15}$ neq/cm 2

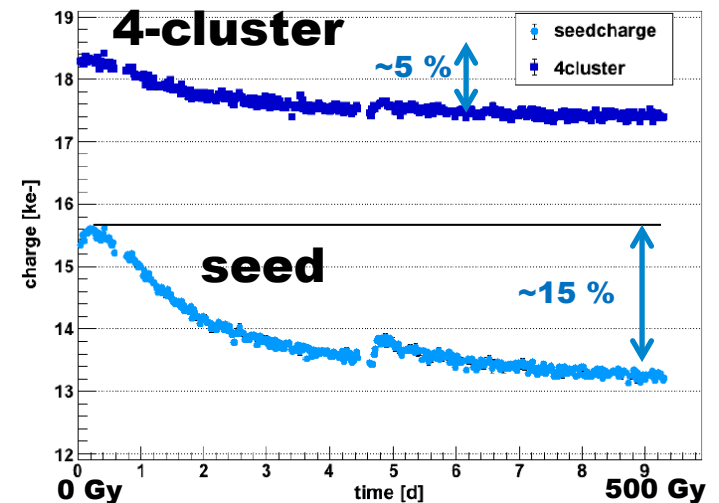
(figures Chr. Henkel, BSC-Thesis)

Charge Losses Surface Damage



- Degradation of Landau-Gaussian distribution due to more charge sharing
- Still 5% reduction in seed strip for $\Phi_{eq} = 2.1 \times 10^{15} \text{ cm}^{-2}$ irradiated sensor
- Depends strongly on strip parameters

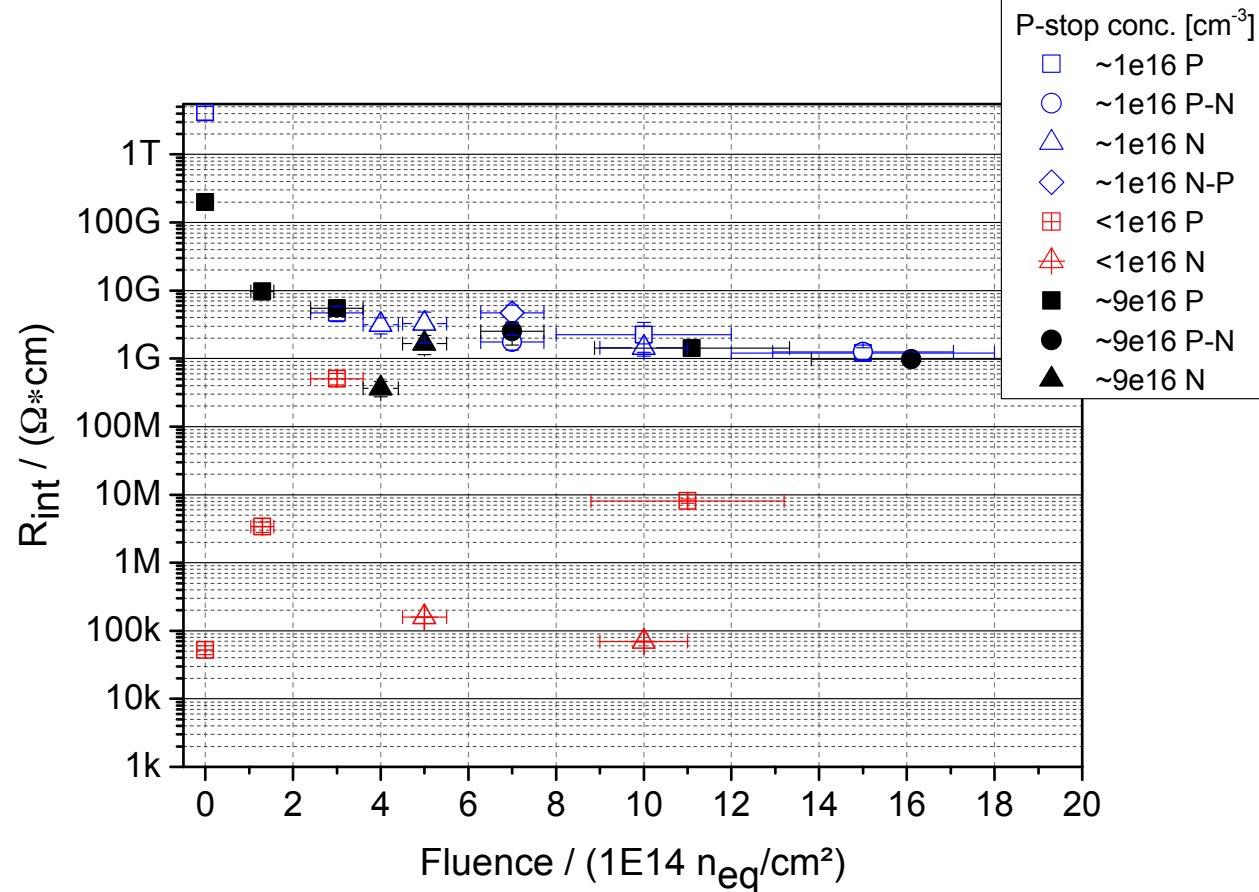
- **ATLAS results do not show this feature**
→ See next talk by A. Dierlamm



Inter-strip Resistance

Strip isolation for n-in-p sensors:
p-stop concentration:

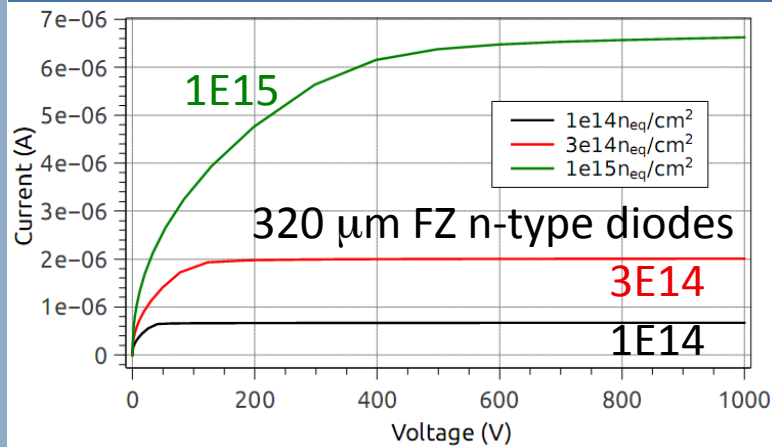
- $< 1 \times 10^{16} \text{ cm}^{-3}$
→ R_{int} in $\text{M}\Omega$ -range
→ Not sufficient
- $> 1 \times 10^{16} \text{ cm}^{-3}$
→ $R_{\text{int}} > 200 \text{ M}\Omega$
→ Sufficient strip isolation
- $= 9 \times 10^{16} \text{ cm}^{-3}$
→ High noise after irradi.



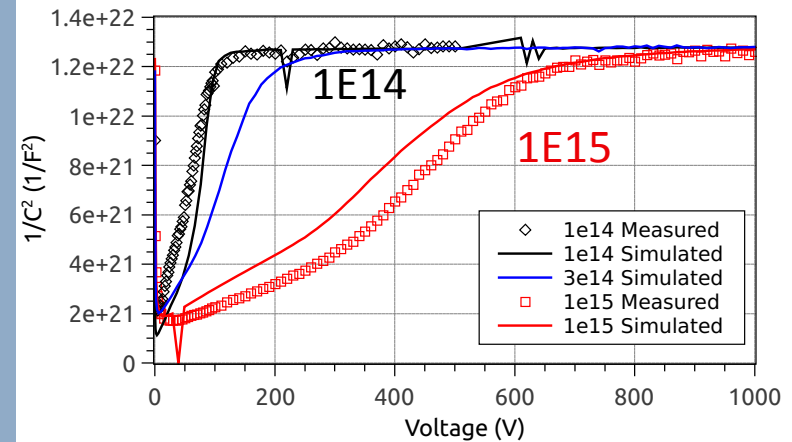
Optimal p-stop concentration between $1 \times 10^{16} \text{ cm}^{-3}$ and $9 \times 10^{16} \text{ cm}^{-3}$

Simulation: Effective Two-Trap Model

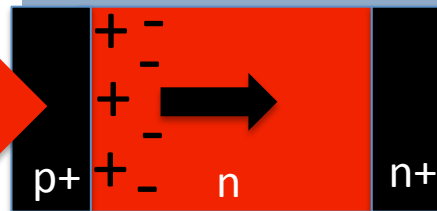
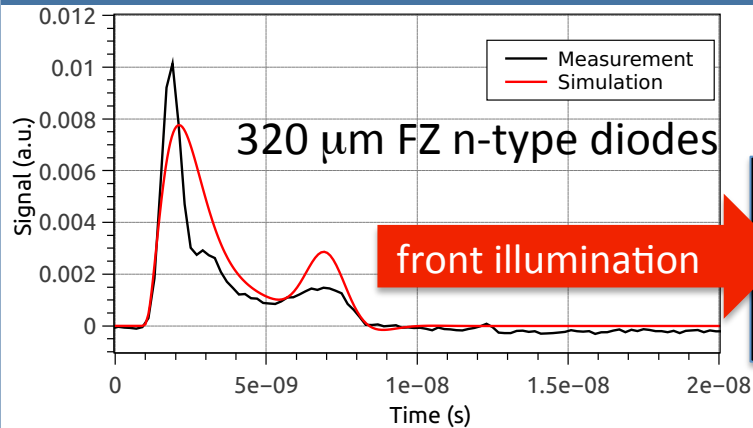
Current-Voltage measurements



Capacitance-Voltage measurements



Red laser TCT measurements



Use comparison of measurement and simulation to adjust parameters for effective donor and acceptor levels:

- Energy levels (E_a)
- Hole & electron capture cross sections ($\sigma_{e,h}$)
- Concentrations (N_D)

Simulation Models

Based in the 2-trap EVL model
V. Eremin, NIM A 535 (2004) 622-63.

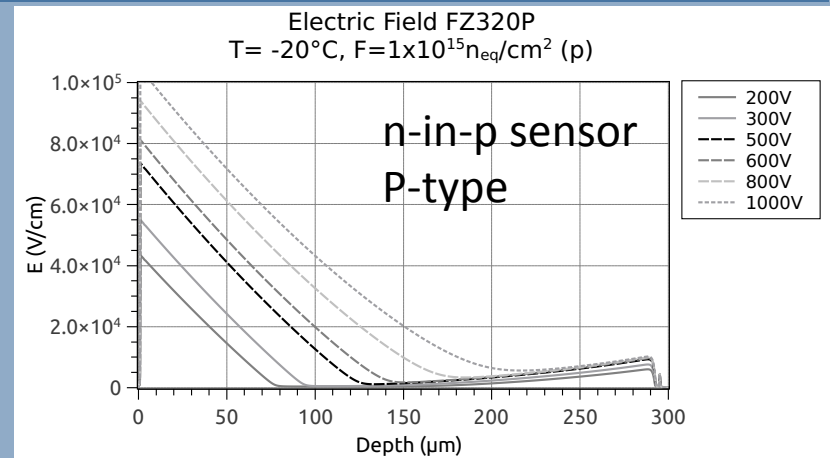
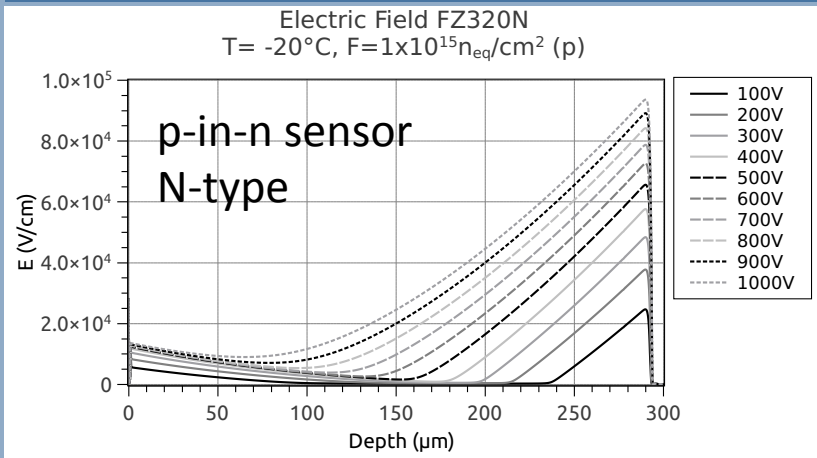
Effective neutron two-trap model:

Parameter	Donor	Acceptor
Energy [eV]	$E_V + 0.48$	$E_C - 0.525$
Concentration [cm^{-3}]	$1.395 \text{ cm}^{-1} \times F$	$1.55 \text{ cm}^{-1} \times F$
σ_e [cm^2]	1.2×10^{-14}	1.2×10^{-14}
σ_h [cm^2]	1.2×10^{-14}	1.2×10^{-14}

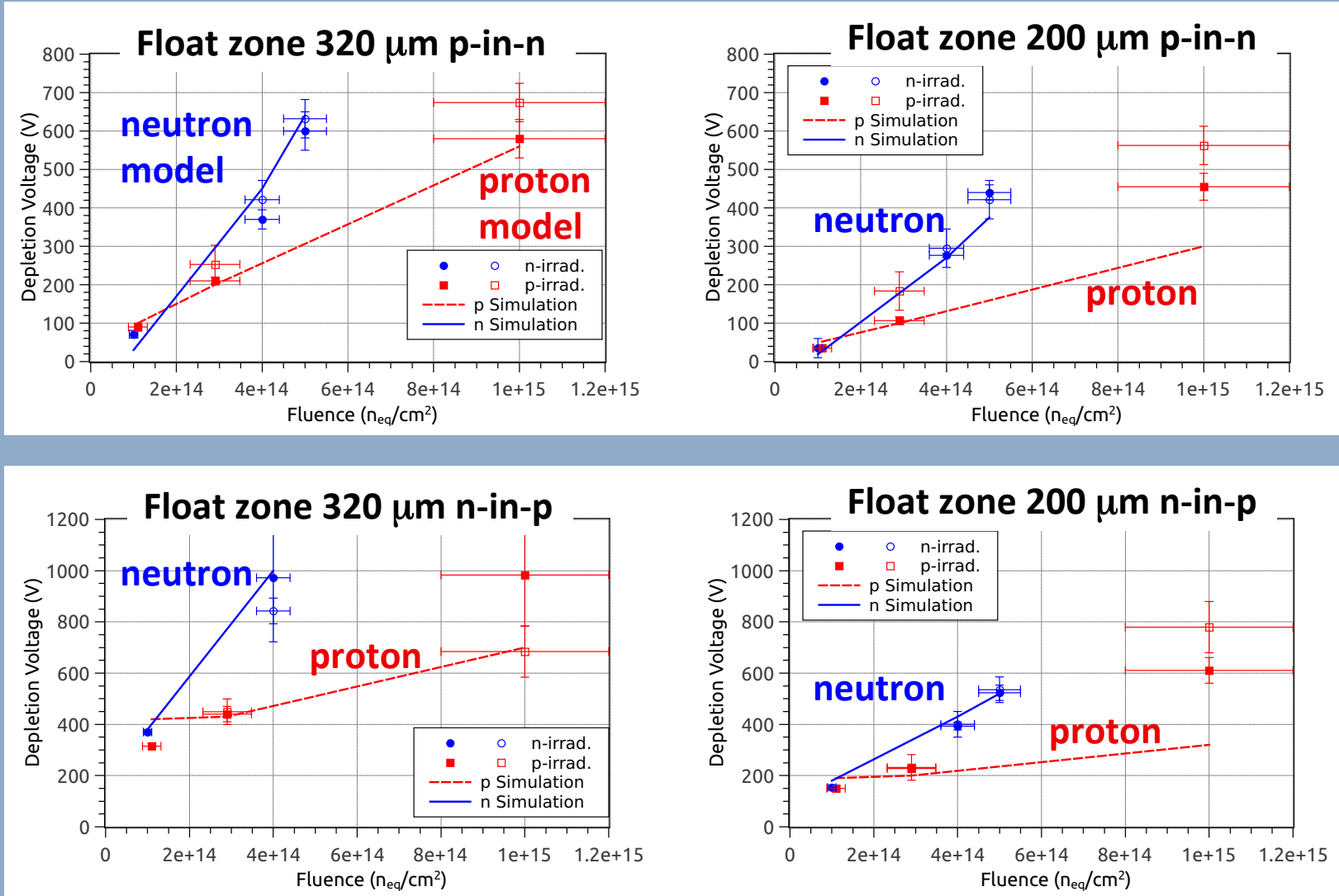
Effective proton two-trap model:

Parameter	Donor	Acceptor
Energy [eV]	$E_V + 0.48$	$E_C - 0.525$
Concentration [cm^{-3}]	$5.598 \text{ cm}^{-1} \times F - 3.949 \cdot 10^{14}$	$1.189 \text{ cm}^{-1} \times F + 6.454 \cdot 10^{13}$
σ_e [cm^2]	1.0×10^{-14}	1.0×10^{-14}
σ_h [cm^2]	1.0×10^{-14}	1.0×10^{-14}

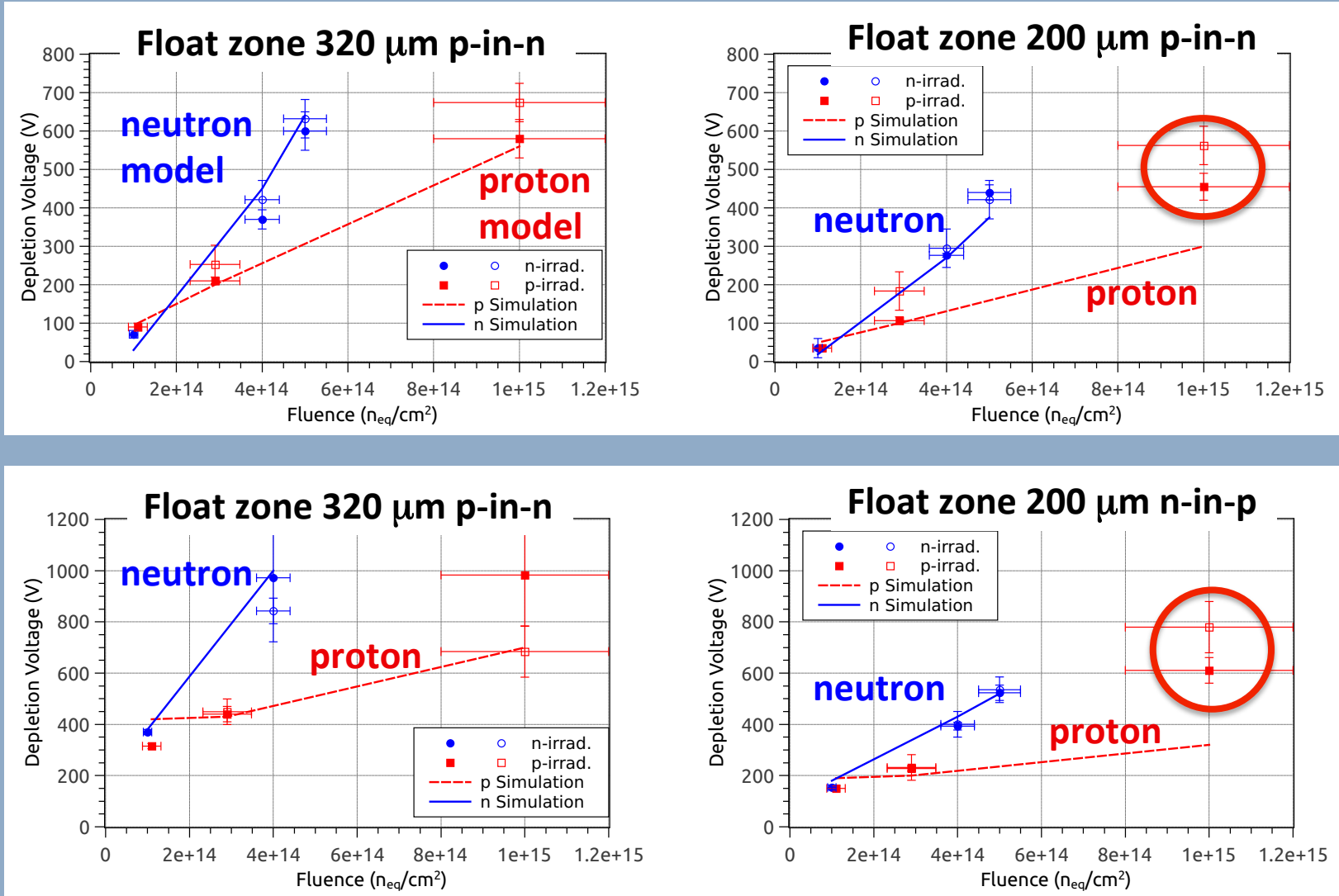
Electric Field at $\Phi = 1 \times 10^{15} \text{ cm}^{-2}$ proton irradiation for 300 μm float zone sensors



Simulation of the Depletion Voltage



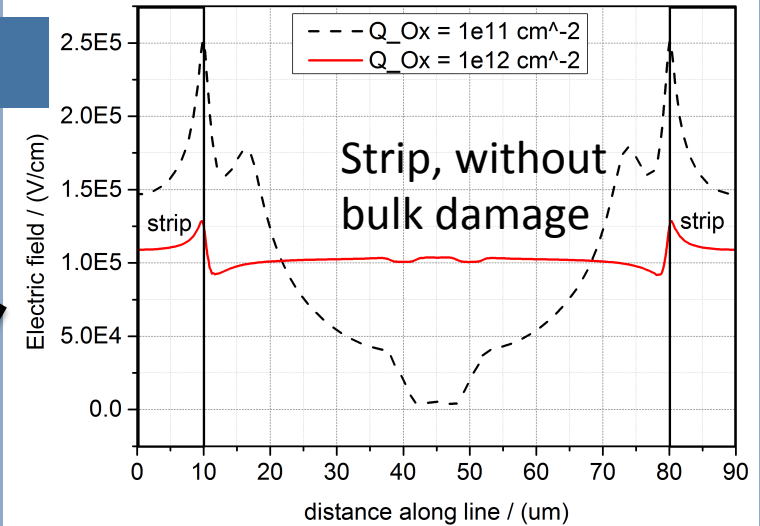
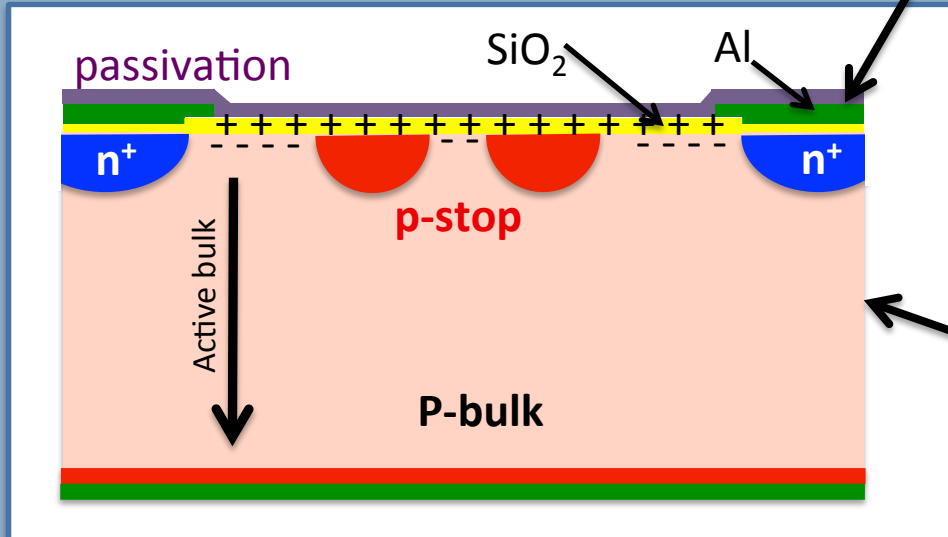
Simulation of the Depletion Voltage



Simulation of electric field

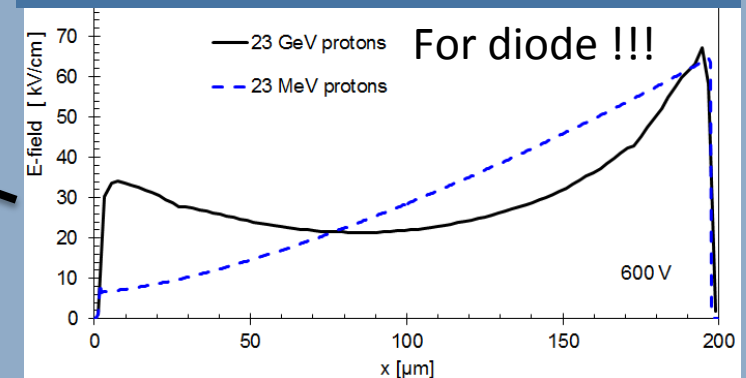
Introducing oxide charges to simulation

Important ingredients to describe an irradiated sensor



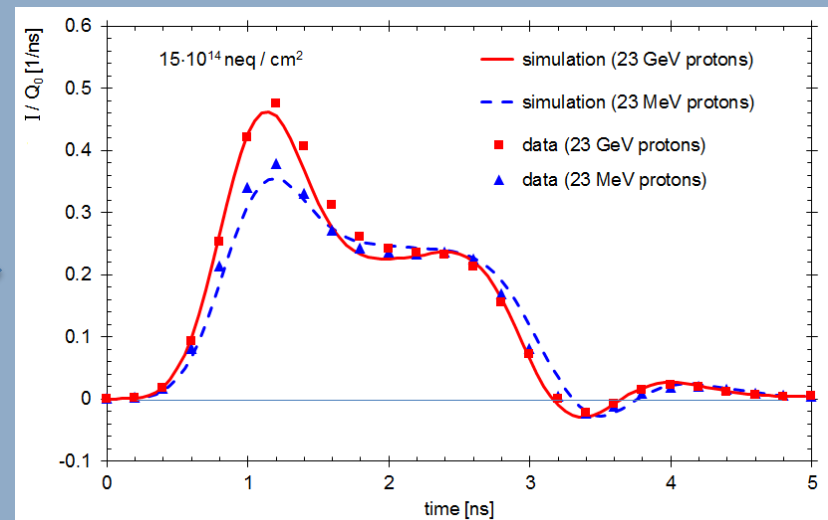
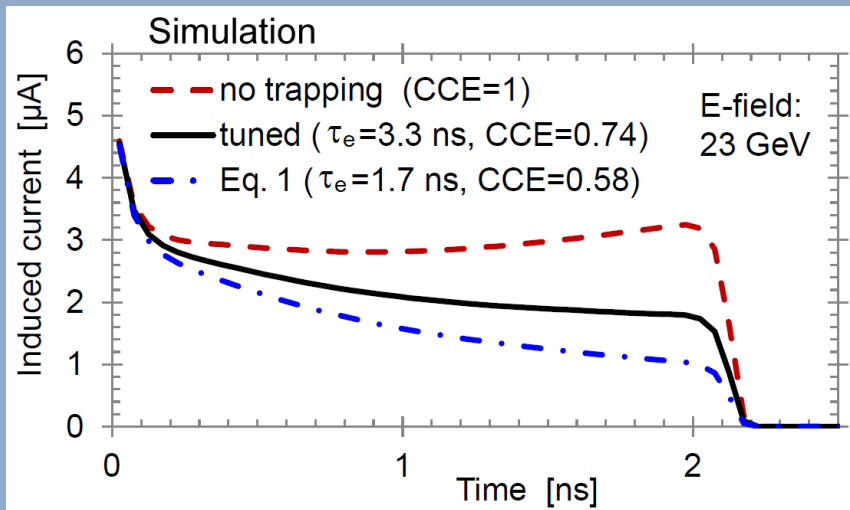
[M.Printz, CMS-CR-2013-267]

Bulk damage



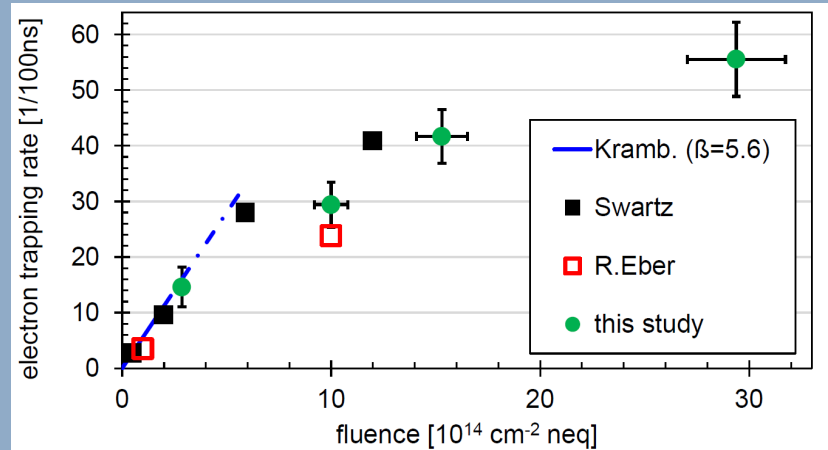
Extraction of effective Trapping Rates

Adjust (tune) simulated time-resolved pulse by varying trapping time until it CCE expectation



Extracted trapping rates for electrons for $\Phi=3 \times 10^{15} \text{ cm}^{-2}$

→ Impact of trapping less severe than expected from extrapolation of measurements at low fluences!!!



Summary

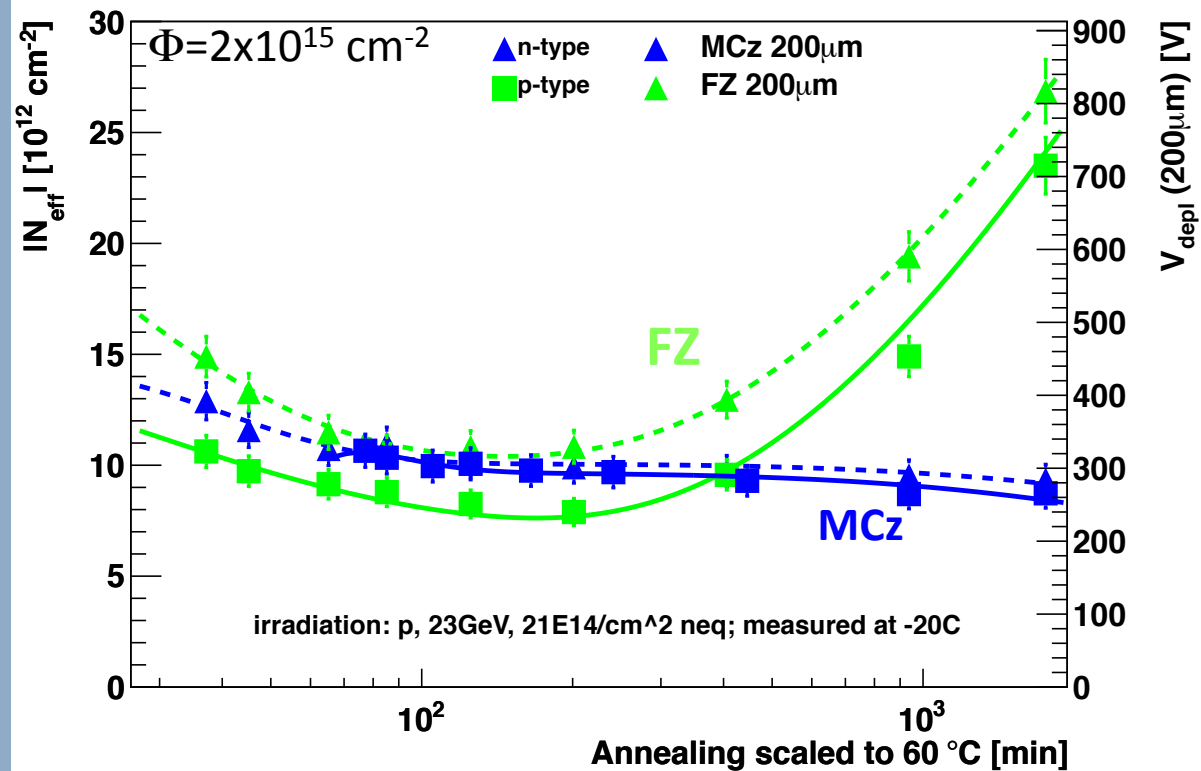
- Bulk defect generation very similar for p-type and n-type
 - Physics motivation to have models valid for both polarities
 - Work required to understand proton damage for different energies
- Impact of surface damage on HL-LHC sensors cannot be neglected
 - Oxide charge included in simulation models
 - Work required to integrate interface states
- Achieved good progress in simulation accuracy for irradiated sensors
 - Effective models for neutrons and protons developed
 - Depletion voltage, leakage current, TCT pulses well reproduced vs. fluence
 - Effective trapping rates extracted

Back up

Annealing Behavior for magnetic Czochralski



23 GeV proton + neutron irradiated pad-diodes



FZ: Depletion requires highervoltage

MCz is much more stable in time

→ Longer “warm” periods possible with MCz